

Models 2601B, 2602B and 2604B

Keithley Instruments, Inc.

28775 Aurora Road Cleveland, Ohio 44139 1-888-KEITHLEY http://www.keithley.com System SourceMeter® Instrument Specifications

SPECIFICATION CONDITIONS

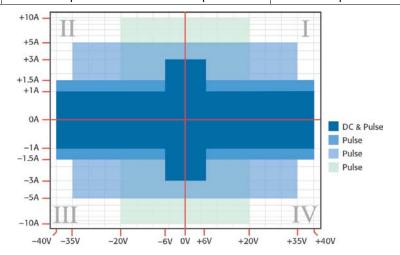
This document contains specifications and supplemental information for the Models 2601B, 2602B and 2604B System SourceMeter® instrument. Specifications are the standards against which the Models 2601B, 2602B and 2604B are tested. Upon leaving the factory, the Models 2601B, 2602B and 2604B meet these specifications. Supplemental and typical values are nonwarranted, apply at 23 °C, and are provided solely as useful information.

Source and measurement accuracies are specified at the Models 2601B, 2602B and 2604B terminals under these conditions:

- 1. 23 °C ± 5 °C, < 70 percent relative humidity
- 2. After a two-hour warm-up period
- 3. Speed normal (1 NPLC)
- 4. A/D autozero enabled
- 5. Remote sense operation or properly zeroed local operation
- 6. Calibration period: One year

DC POWER SPECIFICATIONS

	Voltage	Current
Maximum output	40.4 W maximum	40.4 W maximum
power and source/sink limits 1	■ ± (40.4 V at 1.0 A, -1.0 A)	■ ± (1.01 A at 40 V, -40 V)
Source/Silik illilits	■ ± (6.06 V at 3.0 A, -3.0 A)	■ ± (3.03 A at 6 V, -6 V)
	 Four-quadrant source or sink operation 	 Four-guadrant source or sink operation



Refer to the "Pulse Characteristics" section for pulsing details, such as duty cycle and pulse width.

Specifications are subject to change without notice

¹ Full power source operation regardless of load to 30 °C ambient temperature. Above 30 °C or power sink operation, refer to "Operating Boundaries" in the Series 2600B Reference Manual for additional power derating information.

VOLTAGE ACCURACY SPECIFICATIONS^{2,3}

	Source	Source			
Range	Programming resolution	Accuracy ± (% reading + volts)	Typical Noise (Peak to Peak) 0.1 Hz to 10 Hz	Display resolution	Accuracy ⁴ ± (% reading + volts)
100 mV	5 μV	0.02 % + 250 μV	20 μV	100 nV	0.015 % + 150 μV
1 V	50 μV	0.02 % + 400 μV	50 μV	1 µV	0.015 % + 200 μV
6 V	50 μV	0.02 % + 1.8 mV	100 μV	1 μV	0.015 % + 1 mV
40 V	500 μV	0.02 % + 12 mV	500 μV	10 μV	0.015 % + 8 mV

CURRENT ACCURACY SPECIFICATIONS²

	Source			Measure		
Range	Programming resolution	Accuracy ± (% reading + amperes)	Typical Noise (Peak to Peak) 0.1 Hz to 10 Hz	Display resolution	Accuracy ⁴ ± (% reading + amperes)	
100 nA	2 pA	0.06 % + 100 pA	5 pA	100 fA	0.05 % + 100 pA	
1 μΑ	20 pA	0.03 % + 800 pA	25 pA	1 pA	0.025 % + 500 pA	
10 μΑ	200 pA	0.03 % + 5 nA	60 pA	10 pA	0.025 % + 1.5 nA	
100 µA	2 nA	0.03 % + 60 nA	3 nA	100 pA	0.02 % + 25 nA	
1 mA	20 nA	0.03 % + 300 nA	6 nA	1 nA	0.02 % + 200 nA	
10 mA	200 nA	0.03 % + 6 µA	200 nA	10 nA	0.02 % + 2.5 μA	
100 mA	2 μΑ	0.03 % + 30 μA	600 nA	100 nA	0.02 % + 20 μA	
1 A	20 μΑ	0.05 % + 1.8 mA	70 µA	1 μΑ	0.03 % + 1.5 mA	
3 A	20 μΑ	0.06 % + 4 mA	150 µA	1 μΑ	0.05 % + 3.5 mA	
10 A ⁵	200 μΑ	0.5 % + 40 mA	N/A	10 μΑ	0.4 % + 25 mA	

⁴ Derate accuracy specification for NPLC setting < 1 by increasing the error term. Add appropriate typical percent of reading term for resistive loads using the table below.

NPLC setting	100 mV range	1 V and 40 V ranges	100 nA range 1 µA to 100 mA ranges		1 A to 3 A ranges
0.1	0.01 %	0.01 %	0.01 %	0.01 %	0.01 %
0.01	0.08 %	0.07 %	0.1 %	0.05 %	0.05 %
0.001	0.8 %	0.6 %	1 %	0.5 %	1.1 %

⁵ 10 A range is accessible in pulse mode only. Accuracy specifications for 10 A range are typical.

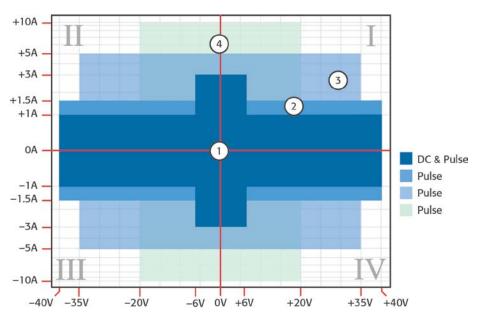
² For temperatures 0 °C to 18 °C and 28 °C to 50 °C, accuracy is degraded by ± (0.15 × accuracy specification)/°C. High Capacitance Mode accuracy is applicable at 23 °C ± 5 °C.

 $^{^{3}}$ Add 50 μV to source accuracy specifications per volt of HI lead drop.

SUPPLEMENTAL CHARACTERISTICS

The following specifications are supplemental characteristics that provide additional information about instrument functions and performance. These characteristics are nonwarranted specifications; they describe the typical performance of the Models 2601B, 2602B and 2604B.

PULSE CHARACTERISTICS



Pulse region specifications	Pulse region specifications					
	Region quadrant diagram	Region maximums	Maximum pulse width ⁶	Maximum duty cycle ⁷		
	1	1 A at 40 V	DC, no limit	100 %		
	1	3 A at 6 V	DC, no limit	100 %		
	2	1.5 A at 40 V	100 ms	25 %		
	3	5 A at 35 V	4 ms	4 %		
	4	10 A at 20 V	1.8 ms	1 %		

⁶ Times measured from the start of pulse to the start off-time; see figure below.



⁷ Thermally limited in sink mode (quadrants 2 and 4) and ambient temperatures above 30° C. See power equations in the Series 2600B Reference Manual for more information.

Minimum programmable pulse width ⁶	100 μs Note: Minimum pulse width for settled source at a given I/V output and load can be longer than 100 ms.					
	Source value	Load	Source settling time (% of range)	Minimum pulse width		
	6 V	2 Ω	0.2 %	150 µs		
	20 V	2 Ω	1 %	200 µs		
	35 V	7 Ω	0.5 %	500 µs		
	40 V	27 Ω	0.1 %	400 µs		
	1.5 A	27 Ω	0.1 %	1.5 ms		
	3 A	2 Ω	0.2 %	150 µs		
	5 A	7 Ω	0.5 %	500 μs		
	10 A	2 Ω	0.5 %	200 μs		
Pulse width programming resolution	1 µs					
Pulse width programming accuracy	± 5 μs					
Pulse width jitter	2 µs					

ADDITIONAL SOURCE CHARACTERISTICS

Noise	< 20 mV peak-peak, < 3 mV RMS				
10 Hz to 20 MHz	■ 6 V range				
Transient response time	< 70 µs for the output to recover to within 0.1 % for a 10 % to 90 % step change in load.				
Overshoot	Voltage:				
	■ < ±0.1 % + 10 mV				
	 Step size = 10 % to 90 % of range, resistive load, maximum current limit/compliance 				
	Current:				
	■ <±0.1 %				
	■ Step size = 10 % to 90 % of range, resistive load				
	■ See <u>Current source output settling time</u> for additional test conditions				
Range change overshoot	Voltage:				
	< 300 mV + 0.1 % of larger range				
	 Overshoot into a 100 kΩ load, 20 MHz bandwidth 				
	Current: ⁸				
	< 300 mV/R _{load} + 5 % of larger range				
Guard offset voltage	< 4 mV				
	■ Current < 10 mA				
Remote sense operating	Maximum voltage between HI and SENSE HI = 3 V				
range ⁹	Maximum voltage between LO and SENSE LO = 3 V				

 $^{^8}$ With source settling set to SETTLE_SMOOTH_100NA 9 Add 50 μV to source accuracy specifications per volt of HI lead drop.

Voltage output headroom	40 V range				
	 Maximum output voltage = 42 V – (total voltage drop across source leads). Maximum 1 Ω source lead. 				
	6 V range				
	 Maximum output voltage = 8 V – (total voltage drop across source leads). Maximum 1 Ω source lead. 				
Over-temperature protection	Internally sensed temperature overload put	ts the instrument in standby mode			
Limit/compliance	Bipolar limit (compliance) set with a single	value			
	Voltage: ¹⁰				
	 Minimum value is 10 mV; accuracy is 	the same as voltage source			
	Current: ¹¹				
	 Minimum value is 10 nA; accuracy is t 	he same as current source			
Voltage source output settling time	Time required to reach within 0.1 % of final value after source level command is processed on a fixed range.				
	Voltage range	Settling time			
	100 mV	< 50 µs			
	1 V	< 50 µs			
	10 V	< 110 μs			
	40 V ¹²	< 150 µs			
Current source output settling time	Time required to reach within 0.1 % of final value after source level command is processed on a fixed range				
	■ Values below for I _{out} × R _{load} = 1 V				
	Current range	Settling time			
	3 A	< 80 μs (Current < 2.5 A, R _{load} > 2 Ω)			
	1 A to 10 mA	$<$ 80 μ s (R _{load} $>$ 6 Ω)			
	1 mA	< 100 µs			
	100 μΑ	< 150 µs			
	10 μΑ	< 500 µs			
	1 μΑ	< 2 ms			
	100 nA	< 20 ms			

¹⁰ For sink operation (quadrants II and IV) without sink mode enabled, add 10 % of compliance range and ±0.02 % of limit settling to the corresponding voltage source accuracy specifications. For 100 mV range add an additional 60 mV of uncertainty. Specifications apply with sink mode enabled.

 ¹¹ For sink operation (quadrants II and IV) without sink mode enabled, add 0.06 % of limit range to the corresponding current limit accuracy specifications. Specifications apply with sink mode enabled.
 12 Add 150 µs when measuring on the 1 A range.

ADDITIONAL MEASUREMENT CHARACTERISTICS

Contact check specifications 13,14	Speed	Maximum measurement to memory for 60 Hz (50	7.000.00
	Fast	1.1 ms (1.2 ms)	5 % + 10 Ω
	Medium	4.1 ms (5 ms)	5 % + 1 Ω
	Slow	36 ms (42 ms)	5 % + 0.3 Ω
Current measure settling time ¹⁵	Time required processed on Values below	lue after source level command is	
	Current range	e	Settling time
	1 mA		< 100 μs
Input impedance	> 10 GΩ		

ADDITIONAL CHARACTERISTICS

Maximum load impedance	Normal mode	High-capacitance mode			
	10 nF	50 μF			
Common mode voltage	250 V DC				
Common mode isolation	> 1 GΩ				
	< 4500 pF				
Sense high input impedance	> 10 GΩ				
Maximum sense lead resistance	1 kΩ for rated accuracy				
Overrange	101 % of source range				
	102 % of measure range				

 $^{^{13}}$ Includes measurement of SENSE HI to HI and SENSE LO to LO contact resistances. 14 Contact check is not available with the Model 2604B.

¹⁵ Compliance equal to 100 mA

HIGH CAPACITANCE MODE 16,17,18

Accuracy specifications	Accuracy specifications are applicable in both Normal and High Capacitance Modes.			
Voltage source output settling time	Time required to reach within 0.1 % of final value after source level command is processed on a fixed range.			
	Current limit = 1 A			
	Voltage range	Settling time with C _{load} = 4.7 µF		
	100 mV	< 200 µs		
	1 V	< 200 µs		
	6 V	< 200 µs		
	40 V	< 7 ms		
Current measure settling time	Time required to reach within 0.1 % of fina processed on a fixed range Values below for Vout = 1 V unless noted	I value after source level command is		
	Current range	Settling time		
	3 A and 1A	< 120 μs (R _{load} > 2 Ω)		
	100 mA and 10 mA	< 100 µs		
	1 mA	< 3 ms		
	100 μΑ	< 3 ms		
	10 μΑ	< 230 ms		
	1 μΑ	< 230 ms		
Capacitor leakage performance	200 ms @ 50 nA			
Using HIGH-C scripts 19	 Load = 5 μF in parallel with 10 MΩ Test: 5 V step and measure 			
Mode change delay	Current ranges of 100 µA and above: 11 ms delay for both in and out of High Capacitance Mode Current ranges below 100 µA: 250 ms delay into High Capacitance Mode 11 ms delay out of High Capacitance Mode			
Voltmeter input impedance	10 GΩ in parallel with 3300 pF			
Noise 10 Hz to 20 MHz	< 30 mV peak-peak 6 V range			
Range change overshoot	Voltage: ■ < 400 mV + 0.1 % of larger range ■ Overshoot into a 100 kΩ load, 20 MHz	z bandwidth		

¹⁶ High Capacitance Mode specifications are for DC measurements only.
17 100 nA range is not available in High Capacitance Mode.
18 High Capacitance Mode utilizes locked ranges. Auto range is disabled.

¹⁹ Part of KI Factory scripts. See the Series 2600B Reference Manual for details.

MEASUREMENT SPEED CHARACTERISTICS^{20,21}

Maximum sweep operation rates (operations per second) for 60 Hz (50 Hz):

A/D converter speed	Trigger origin	Measure to memory	Measure to GPIB	Source measure to memory	Source measure to GPIB	Source measure to memory	Source measure to GPIB
		(using user scripts)	(using user scripts)	(using user scripts)	(using user scripts)	(using sweep API)	(using sweep API)
0.001 NPLC	Internal	20000 (20000)	9800 (9800)	7000 (7000)	6200 (6200)	12000 (12000)	5900 (5900)
0.001 NPLC	Digital I/O	8100 (8100)	7100 (7100)	5500 (5500)	5100 (5100)	11200 (11200)	5700 (5700)
0.01 NPLC	Internal	4900 (4000)	3900 (3400)	3400 (3000)	3200 (2900)	4200 (3700)	4000 (3500)
0.01 NPLC	Digital I/O	3500 (3100)	3400 (3000)	3000 (2700)	2900 (2600)	4150 (3650)	3800 (3400)
0.1 NPLC	Internal	580 (480)	560 (470)	550 (465)	550 (460)	560 (470)	545 (460)
0.1 NPLC	Digital I/O	550 (460)	550 (460)	540 (450)	540 (450)	560 (470)	545 (460)
1.0 NPLC	Internal	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)
1.0 NPLC	Digital I/O	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)

Maximum single measurement rates (operations per second) for 60 Hz (50 Hz):

A/D converter speed	Trigger origin	Measure to GPIB	Source measure to GPIB	Source measure pass/fail to GPIB
0.001 NPLC	Internal	1900 (1800)	1400 (1400)	1400 (1400)
0.01 NPLC	Internal	1450 (1400)	1200 (1200)	1100 (1100)
0.1 NPLC	Internal	450 (390)	425 (370)	425 (375)
1.0 NPLC	Internal	58 (48)	57 (48)	57 (48)

²⁰ Tests performed with a Model 2602B using the following equipment: Computer hardware (Intel® Pentium® 4 2.4 GHz, 2 GB RAM, National Instruments™ PCI-GPIB); driver (NI-488.2 Version 2.2 PCI-GPIB); software (Microsoft® Windows® XP, Microsoft® Visual Studio® 2010, VISA™ version 4.1).

²¹ Exclude current measurement ranges less than 1 mA.

Maximum measurement range change rate	> 7000 per second for > 10 µA. When changing to or from a range ≥ 1 A, maximum rate is > 2200/second.
Maximum source range change rate	> 400 per second > 10 μ A. When changing to or from a range \geq 1 A, maximum rate is > 190/second.
Maximum source function change rate	> 1000 per second
Command processing time	< 1 ms • Maximum time required for the output to begin to change after receiving the smua.source.levelv or smua.source.leveli command.

TRIGGERING AND SYNCHRONIZATION CHARACTERISTICS

Triggering

Trigger in to trigger out	0.5 μs
Trigger in to source change ²²	10 µs
Trigger timer accuracy	±2 µs
Source change ²² after LXI trigger	280 μs

Synchronization

Multi-node synchronized source change ²²	< 0.5 µs
Single-node synchronized source change ²²	< 0.5 µs

²² Fixed source range with no polarity change.

SUPPLEMENTAL INFORMATION

Front-panel interface	Two-line vacuum fluorescent display (VFD) with keypad and navigation wheel
Display	 Show error messages and user-defined messages
	 Display source and limit settings
	 Show current and voltage measurements
	 View measurements stored in dedicated reading buffers
Keypad operations	Change host interface settings
	 Save and restore instrument setups
	 Load and run factory and user-defined test scripts that prompt for input and send results to the display
	Store measurements into dedicated reading buffers
Programming	Embedded Test Script Processor (TSP®) scripting engine is accessible from any host interface:
	 Responds to individual instrument control commands
	 Responds to high-speed test scripts comprised of remote commands and test script language (TSL) statements (for example, branching, looping, and math)
	 Able to execute high-speed test scripts stored in memory without host intervention
Minimum user memory available	16 MB (approximately 250,000 lines of TSP code)
Test Script Builder	Integrated development environment for building, running, and managing TSP scripts; includes an instrument console for interactive communication with any TSP-enabled instrument
	Requires:
	 VISA (NI-VISA included on the Product Information CD-ROM)
	 Microsoft[®] .NET Framework (included on the Product Information CD-ROM)
	 Keithley I/O Layer (included on the Product Information CD-ROM)
	 Intel[®] Pentium III 800 MHz or faster personal computer
	 Microsoft[®] Windows[®] 2000, XP, Vista[®], or 7
TSP [®] Express (embedded)	Tool that allows you to quickly and easily perform common I-V tests without programming or installing software
	To run TSP Express, you need:
	■ Java™ Platform, Standard Edition 6 or 7
	 Microsoft[®] Internet Explorer[®], Mozilla[®] Firefox[®], or another Java-compatible web browser
Software interface	TSP™ Express (embedded), direct GPIB/VISA, read/write with Microsoft [®] Visual Basic [®] , Visual C/C++ [®] , Visual C# [®] , LabVIEW™, CEC TestPoint™ Data Acquisition Software Package, NI LabWindows™/CVI, and so on.

Reading buffers	Nonvolatile memory uses dedicated storage areas reserved for measurement data. Reading buffers are arrays of measurement elements. Each element can store the following items: Measurement Source setting (at the time the measurement was taken) Measurement status Range information Timestamp Reading buffers can be filled using the front-panel STORE key, and retrieved using the RECALL key or host interface.
Buffer size, with timestamp and source setting	> 60,000 samples
Buffer size, without timestamp and source setting	> 140,000 samples
System expansion ²³	The TSP-Link expansion interface allows TSP-enabled instruments to trigger and communicate with each other. See the figure below. To host computer Node 1 Node 2 Each Model 2601B and 2602B has two TSP-Link connectors to make it easier to connect instruments in a sequence. Once source-measure instruments are interconnected through the TSP-Link expansion interface, a computer can access all of the resources of each source-measure instrument through the host interface of any System SourceMeter. A maximum of 32 TSP-Link nodes can be interconnected. Each source-measure

Timing

Timer	Free-running 47-bit counter with 1 MHz clock input. Reset each time instrument power is turned on. If the instrument is not turned off, the timer is automatically reset to zero (0) every four years.
Timestamp	TIMER value is automatically saved when each measurement is triggered
Resolution	1 μs
Timestamp accuracy	±100 ppm

 $^{^{23}}$ TSP-Link is not available with the Model 2604B.

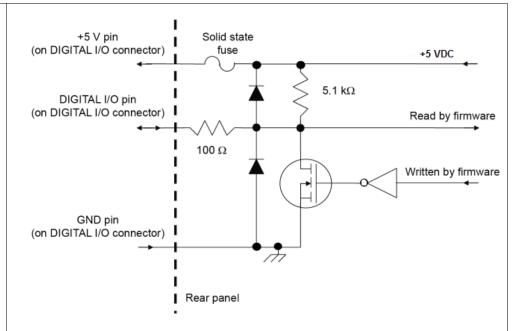
GENERAL SPECIFICATIONS

IEEE-488	IEEE Std 488.1 compliant. Supports IEEE Std 488.2 common commands and status model topology	
RS-232	 Baud rates from 300 bps to 115,200 bps Programmable number of data bits, parity type, and flow control (RTS/CTS hardware or none) When not programmed as the active host interface, the Models 2601B, 2602B and 2604B can use the RS-232 interface to control other instruments 	
Ethernet	RJ-45 connector, LXI version 1.4 Core 2011, 10/100BaseT, Auto-MDIX	
LXI compliance	LXI version 1.4 Core 2011	
Expansion interface ²⁴	 The TSP-Link® expansion interface allows TSP-enabled instruments to trigger and communicate with each other Cable type: Category 5e or higher LAN crossover cable 9.84 ft (3 m) maximum between each TSP-enabled instrument 	
USB Control (Rear)	USB 2.0 Device: USB-TMC488 protocol	
USB File System (Front)	USB 2.0 Host: Mass storage class device	
Power supply	100 V to 240 V AC, 50 Hz or 60 Hz (auto sensing), 240 VA maximum	
Cooling	Forced air; side intake and rear exhaust. One side must be unobstructed when rack mounted.	
Warranty	1 year	
EMC	Conforms to European Union EMC Directive	
Safety	NRTL listed to UL61010-1:2008 and CSA C22.2 No. 61010-1 Conforms to European Union Low Voltage Directive	
Environment	For indoor use only Altitude: Maximum 6562 ft (2000 m) above sea level Operating: 0 °C to 50 °C, 70 % relative humidity up to 35 °C. Derate 3 % relative humidity/°C, 35 °C to 50 °C Storage: -25 °C to 65 °C	
Dimensions	Rack mount: 3.5 in. high × 8.4 in. wide × 17.5 in. deep (89 mm × 213 mm × 460 mm) Bench configuration (with handle and feet): 4.1 in. high × 9.4 in. wide × 17.5 in. deep (104 mm × 238 mm × 460 mm)	
Weight	2601B: 10.4 lb (4.75 kg) 2602B and 2604B: 12.0 lb (5.50 kg)	

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²⁴ TSP-Link is not available with the Model 2604B.

Digital I/O interface²⁵



Connector: 25-pin female D

Input/output pins: 14 open drain I/O bits

Absolute maximum input voltage: 5.25 V

Absolute minimum input voltage: -0.25 V

Maximum logic low input voltage: 0.7V, +850 μA max Minimum logic high input voltage: 2.1 V, +570 μA

Maximum source current (flowing out of digital I/O bit): $+960~\mu A$ Maximum sink current at maximum logic low voltage (0.7): -5.0~mA Absolute maximum sink current (flowing into digital I/O pin: -11~mA

5 V power supply pins: Limited to 250 mA total, solid-state fuse protected

Output Enable: Active high input pulled down internally to ground with a 10 kΩ resistor; when the output enable input function has been activated, each SourceMeter channel will not turn on unless the output enable pin is driven to > 2.1 V (nominal current = 2.1 V / 10 kΩ = 210 μA).

²⁵ The Digital I/O feature is not available with the Model 2604B. Only +5 V, GND and INTERLOCK pins are available with the Model 2604B